

IFW

00862.023490

PATENT APPLICATION



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of:)
: Examiner: David S. Blum
KAZUTAKA YANAGITA ET AL.)
: Group Art Unit: 2813
Application No.: 10/787,195)
: Filed: February 27, 2004)
: For: BONDING SYSTEM AND)
SEMICONDUCTOR)
SUBSTRATE)
MANUFACTURING METHOD : October 31, 2005

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE TO RESTRICTION REQUIREMENT

Sir:

(a) Introductory Comments

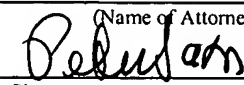
In response to the Office Action dated September 30, 2005, kindly amend
the subject application as follows:

I hereby certify that this correspondence is being deposited with the
United States Postal Service as first-class mail in an envelope addressed
to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-
1450 on

October 31, 2005
(Date of Deposit)

Peter Saxon

(Name of Attorney for Applicant)


Signature

October 31, 2005
Date of Signature